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Docket No.: P5328

FORM PTO-1595 (Modified)  
(Rev. 6-93)  
OMB No. 0651-0011 (exp. 4/94)  
Copyright 1996-97 LegalStar  
P08A/REV02

12-14-1998



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To the Honorable Commissioner

2 SHEET

U. S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

-Y Rec'd U.P.O.  
rd the attached original documents or copy thereof

## 1. Name of conveying party(ies):

Victor A. IOVDALSKY  
Vladimir I. BEIL  
Eduard V. AIZENBERG

MRD 5/26/98

Additional names(s) of conveying party(ies)

☐ Yes ☐ No

## 3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

Execution Date:

## 2. Name and address of receiving party(ies):

Name: Samsung Electronics Co. Ltd.

Address: 416, Maetan-3 Dong, Paldal-Ku,

Suwon City, Gyungki-Do

Republic of Korea

City: State/Prov.:

Country: Korea ZIP:

Additional name(s) &amp; address(es)

☐ Yes ☒ No

## 4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is: October 29, 1996

Patent Application No

Filing date

B. Patent No.(s)

Additional numbers

☐ Yes ☒ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Name: William T. Rifkin

Registration No. 26,501

Address: Rudnick &amp; Wolfe

P.O. Box 64807

City: Chicago

State/Prov.: IL

Country: US

ZIP: 60664-0807

## 6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41): \$ 40.00

☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☒ Authorized to be charged to deposit account

## 8. Deposit account number:

18-2284

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## 9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

William T. Rifkin

Name of Person Signing

Signature

May 26, 1998

Date

Total number of pages including cover sheet, attachments, and

4

PATENT

REEL: 9654 FRAME: 0217

## ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title) \_\_\_\_\_

Microwave Hybrid Integrated Circuit

The PATENT RIGHTS referred to in this agreement are:

- (check one) ☐ a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.
- ☐ U.S. patent application Serial No. \_\_\_\_\_, filed \_\_\_\_\_.
- ☒ a U.S. patent application based on PCT International Application No. PCT/RU 96/00276 filed on (date) 26.09.96 (U.S. patent application Serial No. \_\_\_\_\_, if known).
- ☐ U.S. patent No. \_\_\_\_\_, issued \_\_\_\_\_.

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

- (check one) ☐ U.S. patent rights only.
- ☒ Worldwide patent rights. In this case, the assignee shall have the right to claim the benefit of the filing date of any U.S. or foreign patent application for this invention.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures appear on page 2 of this Assignment and any Supplemental Sheet(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) Samsung Electronics Co., Ltd

Address) 416, Maetan-3 Dong, Paldal-Ku, Suwon City, Gyeonggi-Do,

Republic of Korea

The ASSIGNEE is:

- (check one) ☐ An Individual.
- ☐ A Partnership.
- ☒ A Corporation of Republic of Korea (specify state or country)
- ☐ (other) \_\_\_\_\_

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;

the entire right, title and interest in and to the PATENT RIGHTS;

the right to sue and recover for any past infringement; and,

the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO

ASSIGNEE: Samsung Electronics Co., Ltd

INVENTION TITLE: Microwave Hybrid Integrated Circuit

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any facts known to the ASSIGNOR(S) respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause any and all Letters Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNORS authorize any attorneys and agents who have a power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Victor A. Iordalsky

Name of sole or first inventor

[Signature]  
Signature

29.10.96  
Date

Vladimir T. Beil

Name of second inventor, if any

[Signature]  
Signature

29.10.96  
Date

Edward V. Hizenberg

Name of third inventor, if any

[Signature]  
Signature

29.10.96  
Date

Name of fourth inventor, if any

Signature

Date

Name of fifth inventor, if any

Signature

Date

Name of sixth inventor, if any

Signature

Date

Name of seventh inventor, if any

Signature

Date

Name of eighth inventor, if any

Signature

Date

Name of ninth inventor, if any

Signature

Date